

November 1997 - Revised October 2003

## High-Speed CMOS Logic Quad 2-Input Multiplexer with Three-State Non-Inverting Outputs

### Features

- Buffered Inputs
- Typical Propagation Delay ( In to Output ) = 12ns at  $V_{CC} = 5V$ ,  $C_L = 15pF$ ,  $T_A = 25^{\circ}C$
- Fanout (Over Temperature Range)
  - Standard Outputs . . . . . 10 LSTTL Loads
  - Bus Driver Outputs . . . . . 15 LSTTL Loads
- Wide Operating Temperature Range . . .  $-55^{\circ}C$  to  $125^{\circ}C$
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
  - 2V to 6V Operation
  - High Noise Immunity:  $N_{IL} = 30\%$ ,  $N_{IH} = 30\%$  of  $V_{CC}$  at  $V_{CC} = 5V$
- HCT Types
  - 4.5V to 5.5V Operation
  - Direct LSTTL Input Logic Compatibility,  $V_{IL} = 0.8V$  (Max),  $V_{IH} = 2V$  (Min)
  - CMOS Input Compatibility,  $I_I \leq 1\mu A$  at  $V_{OL}$ ,  $V_{OH}$

### Description

The 'HC257 and 'HCT257 are quad 2-input multiplexers which select four bits of data from two sources under the control of a common Select Input (S). The Output Enable input ( $\overline{OE}$ ) is active LOW. When  $\overline{OE}$  is HIGH, all of the outputs (1Y-4Y) are in the high impedance state regardless of

all other input conditions.

Moving data from two groups of registers to four common output buses is a common use of the 257. The state of the Select input determines the particular register from which the data comes. It can also be used as a function generator.

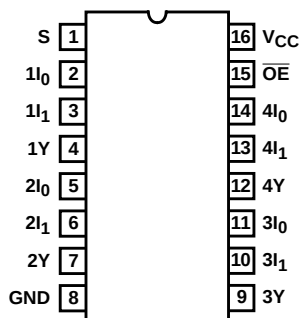
### Ordering Information

| PART NUMBER   | TEMP. RANGE<br>( $^{\circ}C$ ) | PACKAGE      |
|---------------|--------------------------------|--------------|
| CD54HC257F3A  | -55 to 125                     | 16 Ld CERDIP |
| CD54HCT257F3A | -55 to 125                     | 16 Ld CERDIP |
| CD74HC257E    | -55 to 125                     | 16 Ld PDIP   |
| CD74HC257M    | -55 to 125                     | 16 Ld SOIC   |
| CD74HC257MT   | -55 to 125                     | 16 Ld SOIC   |
| CD74HC257M96  | -55 to 125                     | 16 Ld SOIC   |
| CD74HCT257E   | -55 to 125                     | 16 Ld PDIP   |
| CD74HCT257M   | -55 to 125                     | 16 Ld SOIC   |
| CD74HCT257MT  | -55 to 125                     | 16 Ld SOIC   |
| CD74HCT257M96 | -55 to 125                     | 16 Ld SOIC   |

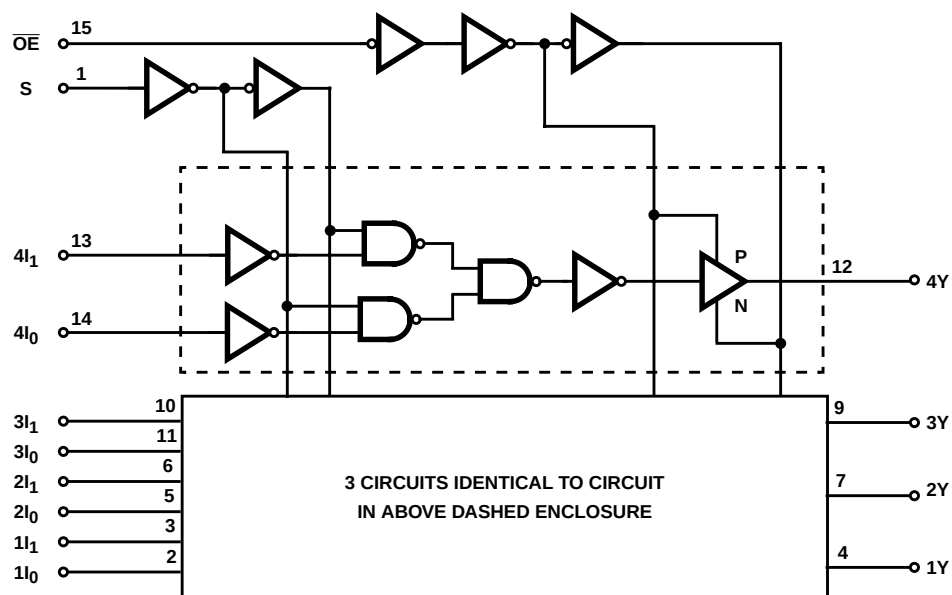
NOTE: When ordering, use the entire part number. The suffix 96 denotes tape and reel. The suffix T denotes a small-quantity reel of 250.

### Pinout

CD54HC257, CD54HCT257  
(CERDIP)  
CD74HC257, CD74HCT257  
(PDIP, SOIC)  
TOP VIEW



## Functional Diagram



TRUTH TABLE

| OUTPUT<br>ENABLE | SELECT<br>INPUT | DATA INPUTS    |                | OUTPUT |
|------------------|-----------------|----------------|----------------|--------|
| OE               | S               | I <sub>0</sub> | I <sub>1</sub> | Y      |
| H                | X               | X              | X              | Z      |
| L                | L               | L              | X              | L      |
| L                | L               | H              | X              | H      |
| L                | H               | X              | L              | L      |
| L                | H               | X              | H              | H      |

H= High Voltage Level

L= Low Voltage Level

X= Don't Care

Z= High Impedance, OFF State

# CD54HC257, CD74HC257, CD54HCT257, CD74HCT257

## Absolute Maximum Ratings

DC Supply Voltage,  $V_{CC}$  ..... -0.5V to 7V  
 DC Input Diode Current,  $I_{IK}$   
 For  $V_I < -0.5V$  or  $V_I > V_{CC} + 0.5V$  .....  $\pm 20mA$   
 DC Output Diode Current,  $I_{OK}$   
 For  $V_O < -0.5V$  or  $V_O > V_{CC} + 0.5V$  .....  $\pm 20mA$   
 DC Drain Current, per Output,  $I_O$   
 For  $-0.5V < V_O < V_{CC} + 0.5V$  .....  $\pm 35mA$   
 DC Output Source or Sink Current per Output Pin,  $I_O$   
 For  $V_O > -0.5V$  or  $V_O < V_{CC} + 0.5V$  .....  $\pm 25mA$   
 DC  $V_{CC}$  or Ground Current,  $I_{CC}$  .....  $\pm 70mA$

## Thermal Information

Thermal Resistance (Typical, Note 1)  $\theta_{JA}$  ( $^{\circ}C/W$ )  
 E (PDIP) Package ..... 67  
 M (SOIC) Package ..... 73  
 Maximum Junction Temperature .....  $150^{\circ}C$   
 Maximum Storage Temperature Range .....  $-65^{\circ}C$  to  $150^{\circ}C$   
 Maximum Lead Temperature (Soldering 10s) .....  $300^{\circ}C$   
 (SOIC - Lead Tips Only)

## Operating Conditions

Temperature Range,  $T_A$  .....  $-55^{\circ}C$  to  $125^{\circ}C$   
 Supply Voltage Range,  $V_{CC}$   
 HC Types ..... 2V to 6V  
 HCT Types ..... 4.5V to 5.5V  
 DC Input or Output Voltage,  $V_I$ ,  $V_O$  ..... 0V to  $V_{CC}$   
 Input Rise and Fall Time  
 2V ..... 1000ns (Max)  
 4.5V ..... 500ns (Max)  
 6V ..... 400ns (Max)

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### NOTE:

1. The package thermal impedance is calculated in accordance with JESD 51-7.

## DC Electrical Specifications

| PARAMETER                               | SYMBOL          | TEST CONDITIONS                       |                     | V <sub>CC</sub> (V) | 25°C |     |      | -40°C TO 85°C |      | -55°C TO 125°C |      | UNITS |
|-----------------------------------------|-----------------|---------------------------------------|---------------------|---------------------|------|-----|------|---------------|------|----------------|------|-------|
|                                         |                 | V <sub>I</sub> (V)                    | I <sub>O</sub> (mA) |                     | MIN  | TYP | MAX  | MIN           | MAX  | MIN            | MAX  |       |
| HC TYPES                                |                 |                                       |                     |                     |      |     |      |               |      |                |      |       |
| High Level Input Voltage                | V <sub>IH</sub> | -                                     | -                   | 2                   | 1.5  | -   | -    | 1.5           | -    | 1.5            | -    | V     |
|                                         |                 |                                       |                     | 4.5                 | 3.15 | -   | -    | 3.15          | -    | 3.15           | -    | V     |
|                                         |                 |                                       |                     | 6                   | 4.2  | -   | -    | 4.2           | -    | 4.2            | -    | V     |
| Low Level Input Voltage                 | V <sub>IL</sub> | -                                     | -                   | 2                   | -    | -   | 0.5  | -             | 0.5  | -              | 0.5  | V     |
|                                         |                 |                                       |                     | 4.5                 | -    | -   | 1.35 | -             | 1.35 | -              | 1.35 | V     |
|                                         |                 |                                       |                     | 6                   | -    | -   | 1.8  | -             | 1.8  | -              | 1.8  | V     |
| High Level Output Voltage<br>CMOS Loads | V <sub>OH</sub> | V <sub>IH</sub> or<br>V <sub>IL</sub> | -0.02               | 2                   | 1.9  | -   | -    | 1.9           | -    | 1.9            | -    | V     |
|                                         |                 |                                       | -0.02               | 4.5                 | 4.4  | -   | -    | 4.4           | -    | 4.4            | -    | V     |
|                                         |                 |                                       | -0.02               | 6                   | 5.9  | -   | -    | 5.9           | -    | 5.9            | -    | V     |
| High Level Output Voltage<br>TTL Loads  |                 |                                       | -6                  | 4.5                 | 3.98 | -   | -    | 3.84          | -    | 3.7            | -    | V     |
|                                         |                 |                                       | -7.8                | 6                   | 5.48 | -   | -    | 5.34          | -    | 5.2            | -    | V     |
| Low Level Output Voltage<br>CMOS Loads  | V <sub>OL</sub> | V <sub>IH</sub> or<br>V <sub>IL</sub> | 0.02                | 2                   | -    | -   | 0.1  | -             | 0.1  | -              | 0.1  | V     |
|                                         |                 |                                       | 0.02                | 4.5                 | -    | -   | 0.1  | -             | 0.1  | -              | 0.1  | V     |
|                                         |                 |                                       | 0.02                | 6                   | -    | -   | 0.1  | -             | 0.1  | -              | 0.1  | V     |
| Low Level Output Voltage<br>TTL Loads   |                 |                                       | 6                   | 4.5                 | -    | -   | 0.26 | -             | 0.33 | -              | 0.4  | V     |
|                                         |                 |                                       | 7.8                 | 6                   | -    | -   | 0.26 | -             | 0.33 | -              | 0.4  | V     |
| Input Leakage Current                   | I <sub>I</sub>  | V <sub>CC</sub> or<br>GND             | -                   | 6                   | -    | -   | ±0.1 | -             | ±1   | -              | ±1   | μA    |

**CD54HC257, CD74HC257, CD54HCT257, CD74HCT257**

**DC Electrical Specifications (Continued)**

| PARAMETER                                                      | SYMBOL                      | TEST CONDITIONS      |            | $V_{CC}$ (V) | 25°C |     |           | -40°C TO 85°C |         | -55°C TO 125°C |          | UNITS   |
|----------------------------------------------------------------|-----------------------------|----------------------|------------|--------------|------|-----|-----------|---------------|---------|----------------|----------|---------|
|                                                                |                             | $V_I$ (V)            | $I_O$ (mA) |              | MIN  | TYP | MAX       | MIN           | MAX     | MIN            | MAX      |         |
| Quiescent Device Current                                       | $I_{CC}$                    | $V_{CC}$ or GND      | 0          | 6            | -    | -   | 8         | -             | 80      | -              | 160      | $\mu A$ |
| Three-State Leakage Current                                    | $I_{OZ}$                    | $V_{IL}$ or $V_{IH}$ | -          | 6            | -    | -   | $\pm 0.5$ | -             | $\pm 5$ | -              | $\pm 10$ | $\mu A$ |
| <b>HCT TYPES</b>                                               |                             |                      |            |              |      |     |           |               |         |                |          |         |
| High Level Input Voltage                                       | $V_{IH}$                    | -                    | -          | 4.5 to 5.5   | 2    | -   | -         | 2             | -       | 2              | -        | V       |
| Low Level Input Voltage                                        | $V_{IL}$                    | -                    | -          | 4.5 to 5.5   | -    | -   | 0.8       | -             | 0.8     | -              | 0.8      | V       |
| High Level Output Voltage<br>CMOS Loads                        | $V_{OH}$                    | $V_{IH}$ or $V_{IL}$ | -0.02      | 4.5          | 4.4  | -   | -         | 4.4           | -       | 4.4            | -        | V       |
| High Level Output Voltage<br>TTL Loads                         |                             |                      | -6         | 4.5          | 3.98 | -   | -         | 3.84          | -       | 3.7            | -        | V       |
| Low Level Output Voltage<br>CMOS Loads                         | $V_{OL}$                    | $V_{IH}$ or $V_{IL}$ | 0.02       | 4.5          | -    | -   | 0.1       | -             | 0.1     | -              | 0.1      | V       |
| Low Level Output Voltage<br>TTL Loads                          |                             |                      | 6          | 4.5          | -    | -   | 0.26      | -             | 0.33    | -              | 0.4      | V       |
| Input Leakage Current                                          | $I_I$                       | $V_{CC}$ to GND      | 0          | 5.5          | -    | -   | $\pm 0.1$ | -             | $\pm 1$ | -              | $\pm 1$  | $\mu A$ |
| Quiescent Device Current                                       | $I_{CC}$                    | $V_{CC}$ or GND      | 0          | 5.5          | -    | -   | 8         | -             | 80      | -              | 160      | $\mu A$ |
| Additional Quiescent Device Current Per Input Pin: 1 Unit Load | $\Delta I_{CC}$<br>(Note 2) | $V_{CC}$ -2.1        | -          | 4.5 to 5.5   | -    | 100 | 360       | -             | 450     | -              | 490      | $\mu A$ |
| Three-State Leakage Current                                    | $I_{OZ}$                    | $V_{IL}$ or $V_{IH}$ | -          | 5.5          | -    | -   | $\pm 0.5$ | -             | $\pm 5$ | -              | $\pm 10$ | $\mu A$ |

NOTE:

- For dual-supply systems theoretical worst case ( $V_I = 2.4V$ ,  $V_{CC} = 5.5V$ ) specification is 1.8mA.

**HCT Input Loading Table**

| INPUT           | UNIT LOADS |
|-----------------|------------|
| Data            | 0.95       |
| S               | 3          |
| $\overline{OE}$ | 0.6        |

NOTE: Unit Load is  $\Delta I_{CC}$  limit specified in DC Electrical Specifications table, e.g., 360 $\mu A$  max at 25°C.

**CD54HC257, CD74HC257, CD54HCT257, CD74HCT257**

**Switching Specifications** Input  $t_r, t_f = 6\text{ns}$

| PARAMETER                                  | SYMBOL                                                                       | TEST CONDITIONS       | V <sub>CC</sub> (V) | 25°C |     | -40°C TO 85°C | -55°C TO 125°C | UNITS |
|--------------------------------------------|------------------------------------------------------------------------------|-----------------------|---------------------|------|-----|---------------|----------------|-------|
|                                            |                                                                              |                       |                     | TYP  | MAX | MAX           | MAX            |       |
| HC TYPES                                   |                                                                              |                       |                     |      |     |               |                |       |
| Propagation Delay<br>In to Y               | t <sub>PLH</sub> , t <sub>PHL</sub>                                          | C <sub>L</sub> = 50pF | 2                   | -    | 150 | 190           | 225            | ns    |
|                                            |                                                                              |                       | 4.5                 | -    | 30  | 38            | 45             | ns    |
|                                            |                                                                              | C <sub>L</sub> = 15pF | 5                   | 12   | -   | -             | -              | ns    |
|                                            |                                                                              | CL = 50pF             | 6                   | -    | 26  | 33            | 38             | ns    |
| Propagation Delay<br>S to Y                | t <sub>PLH</sub> , t <sub>PHL</sub>                                          | C <sub>L</sub> = 50pF | 2                   | -    | 175 | 220           | 265            | ns    |
|                                            |                                                                              |                       | 4.5                 | -    | 35  | 44            | 53             | ns    |
|                                            |                                                                              | C <sub>L</sub> = 15pF | 5                   | 14   | -   | -             | -              | ns    |
|                                            |                                                                              | CL = 50pF             | 6                   | -    | 30  | 37            | 45             | ns    |
| Propagation Delay<br>OE to Y               | t <sub>PLZ</sub> , t <sub>PHZ</sub> ,<br>t <sub>PZL</sub> , t <sub>PZH</sub> | CL = 50pF             | 2                   | -    | 150 | 190           | 225            | ns    |
|                                            |                                                                              | C <sub>L</sub> = 50pF | 4.5                 | -    | 30  | 38            | 45             | ns    |
|                                            |                                                                              | C <sub>L</sub> = 15pF | 5                   | 12   | -   | -             | -              | ns    |
|                                            |                                                                              | CL = 50pF             | 6                   | -    | 26  | 33            | 38             | ns    |
| Output Transition Times                    | t <sub>TLH</sub> , t <sub>THL</sub>                                          | C <sub>L</sub> = 50pF | 2                   | -    | 60  | 75            | 90             | ns    |
|                                            |                                                                              |                       | 4.5                 | -    | 12  | 15            | 18             | ns    |
|                                            |                                                                              |                       | 6                   | -    | 10  | 13            | 15             | ns    |
| Input Capacitance                          | C <sub>I</sub>                                                               | -                     | -                   | -    | 10  | 10            | 10             | pF    |
| Three-State Output Capacitance             | C <sub>O</sub>                                                               | -                     | -                   | -    | 20  | 20            | 20             | pF    |
| Power Dissipation Capacitance (Notes 3, 4) | C <sub>PD</sub>                                                              | -                     | 5                   | 45   | -   | -             | -              | pF    |
| HCT TYPES                                  |                                                                              |                       |                     |      |     |               |                |       |
| Propagation Delay<br>In to Y               | t <sub>PLH</sub> , t <sub>PHL</sub>                                          | C <sub>L</sub> = 50pF | 4.5                 | -    | 33  | 41            | 50             | ns    |
|                                            |                                                                              | C <sub>L</sub> = 15pF | 5                   | 13   | -   | -             | -              | ns    |
| Propagation Delay<br>S to Y                | t <sub>PZL</sub> , t <sub>PZH</sub>                                          | C <sub>L</sub> = 50pF | 4.5                 | -    | 38  | 48            | 57             | ns    |
|                                            |                                                                              | C <sub>L</sub> = 15pF | 5                   | 12   | -   | -             | -              | ns    |
| Propagation Delay<br>OE to Y               | t <sub>PLZ</sub> , t <sub>PHZ</sub>                                          | C <sub>L</sub> = 50pF | 4.5                 | -    | 30  | 38            | 45             | ns    |
|                                            |                                                                              | C <sub>L</sub> = 15pF | 5                   | 16   | -   | -             | -              | ns    |
| Output Transition Times                    | t <sub>TLH</sub> , t <sub>THL</sub>                                          | C <sub>L</sub> = 50pF | 4.5                 | -    | 12  | 15            | 18             | ns    |
| Input Capacitance                          | C <sub>I</sub>                                                               | -                     | -                   | -    | 10  | 10            | 10             | pF    |
| Three-State Output Capacitance             | C <sub>O</sub>                                                               | -                     | -                   | -    | 20  | 20            | 20             | pF    |
| Power Dissipation Capacitance (Notes 3, 4) | C <sub>PD</sub>                                                              | -                     | 5                   | 45   | -   | -             | -              | pF    |

NOTES:

- $C_{PD}$  is used to determine the dynamic power consumption, per multiplexer.
- $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$  where  $f_i$  = Input Frequency,  $C_L$  = Output Load Capacitance,  $V_{CC}$  = Supply Voltage.

## Test Circuits and Waveforms

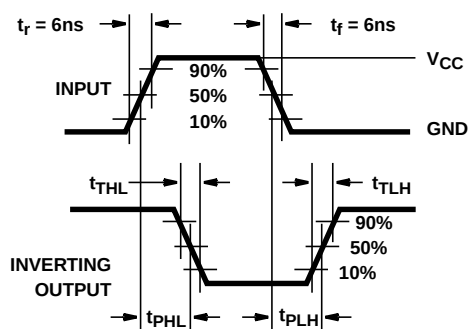


FIGURE 1. HC TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

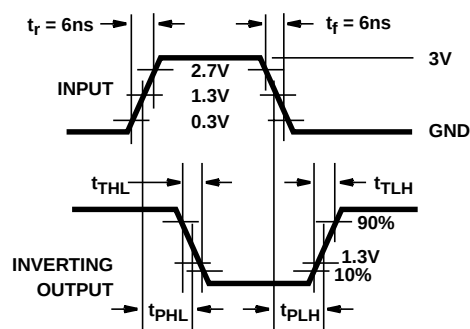


FIGURE 2. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

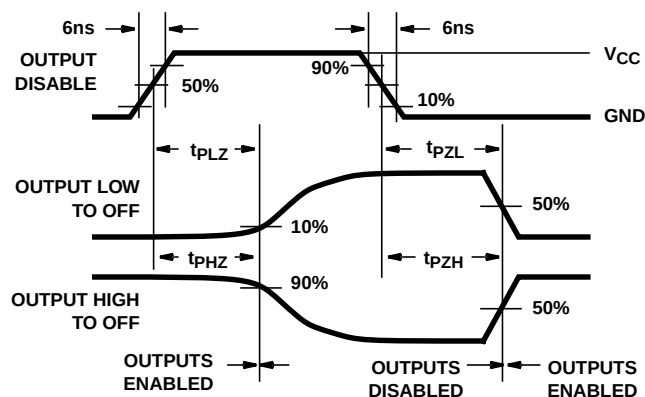


FIGURE 3. HC THREE-STATE PROPAGATION DELAY WAVEFORM

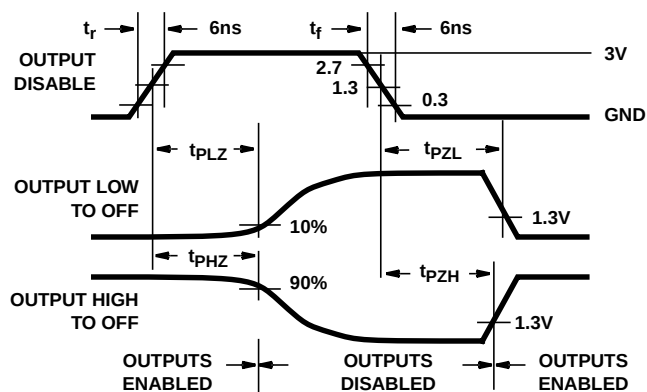
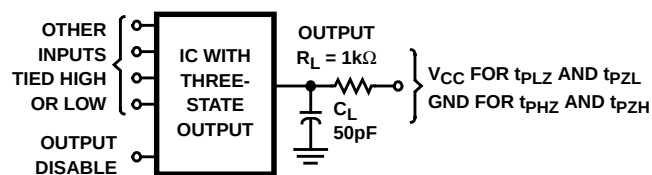


FIGURE 4. HCT THREE-STATE PROPAGATION DELAY WAVEFORM



NOTE: Open drain waveforms  $t_{PLZ}$  and  $t_{PZL}$  are the same as those for three-state shown on the left. The test circuit is Output  $R_L = 1k\Omega$  to  $V_{CC}$ ,  $C_L = 50pF$ .

FIGURE 5. HC AND HCT THREE-STATE PROPAGATION DELAY TEST CIRCUIT

## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)             |
|--------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------------------|
| <a href="#">5962-8970501EA</a> | Active        | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8970501EA<br>CD54HCT257F3A |
| <a href="#">CD54HC257F3A</a>   | Active        | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 8512401EA<br>CD54HC257F3A       |
| CD54HC257F3A.A                 | Active        | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 8512401EA<br>CD54HC257F3A       |
| <a href="#">CD54HCT257F3A</a>  | Active        | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8970501EA<br>CD54HCT257F3A |
| CD54HCT257F3A.A                | Active        | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8970501EA<br>CD54HCT257F3A |
| <a href="#">CD74HC257E</a>     | Active        | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74HC257E                      |
| CD74HC257E.A                   | Active        | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74HC257E                      |
| <a href="#">CD74HC257M</a>     | Obsolete      | Production           | SOIC (D)   16  | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | HC257M                          |
| <a href="#">CD74HC257M96</a>   | Active        | Production           | SOIC (D)   16  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC257M                          |
| CD74HC257M96.A                 | Active        | Production           | SOIC (D)   16  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HC257M                          |
| <a href="#">CD74HCT257E</a>    | Active        | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74HCT257E                     |
| CD74HCT257E.A                  | Active        | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74HCT257E                     |
| <a href="#">CD74HCT257M</a>    | Obsolete      | Production           | SOIC (D)   16  | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | HCT257M                         |
| <a href="#">CD74HCT257M96</a>  | Active        | Production           | SOIC (D)   16  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HCT257M                         |
| CD74HCT257M96.A                | Active        | Production           | SOIC (D)   16  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | HCT257M                         |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF CD54HC257, CD54HCT257, CD74HC257, CD74HCT257 :**

- Catalog : [CD74HC257](#), [CD74HCT257](#)
- Military : [CD54HC257](#), [CD54HCT257](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications



## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD74HC257M96  | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD74HCT257M96 | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74HC257M96  | SOIC         | D               | 16   | 2500 | 340.5       | 336.1      | 32.0        |
| CD74HCT257M96 | SOIC         | D               | 16   | 2500 | 353.0       | 353.0      | 32.0        |

## TUBE

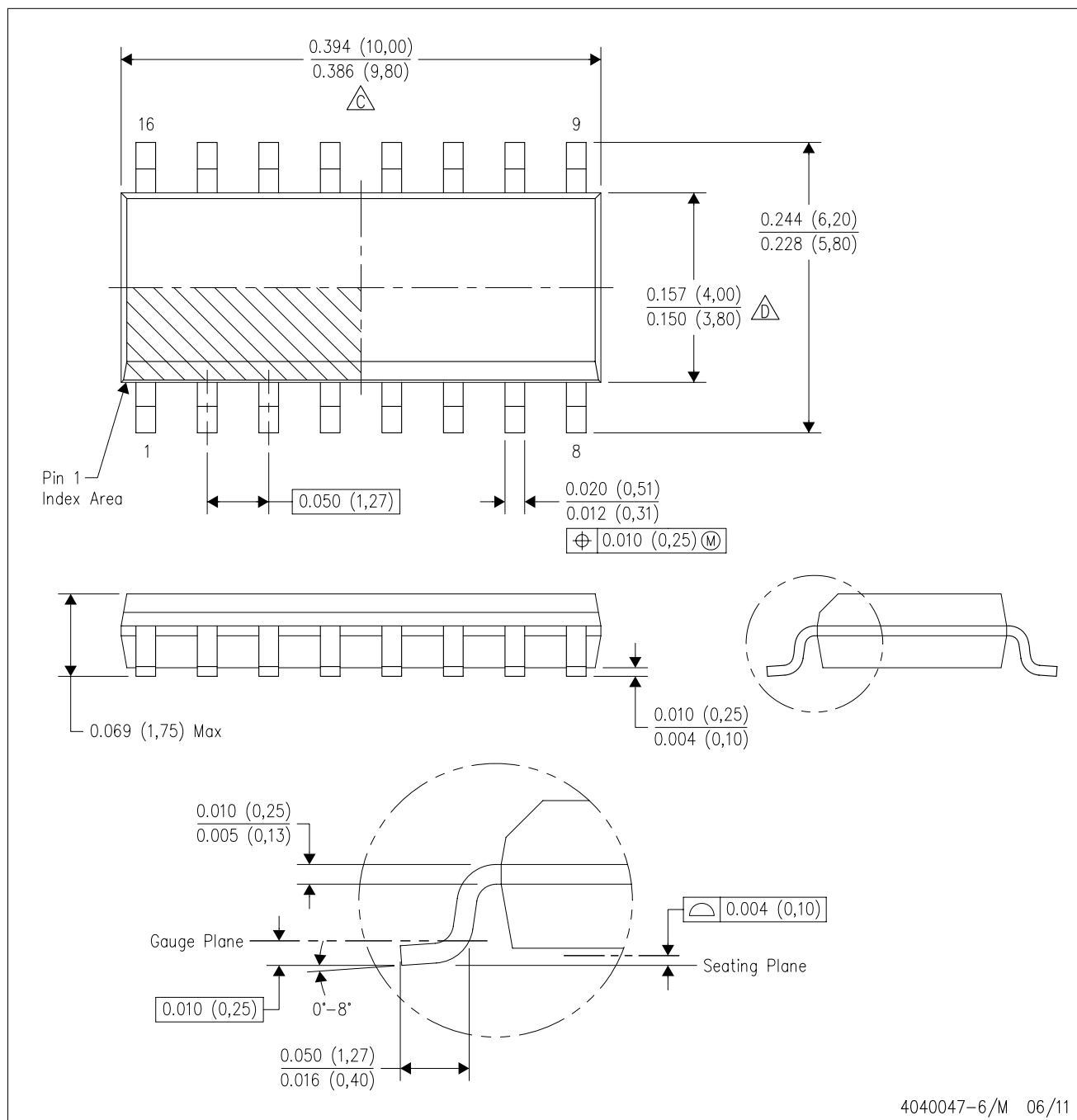


\*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD74HC257E    | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC257E    | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC257E.A  | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC257E.A  | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HCT257E   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HCT257E   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HCT257E.A | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HCT257E.A | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



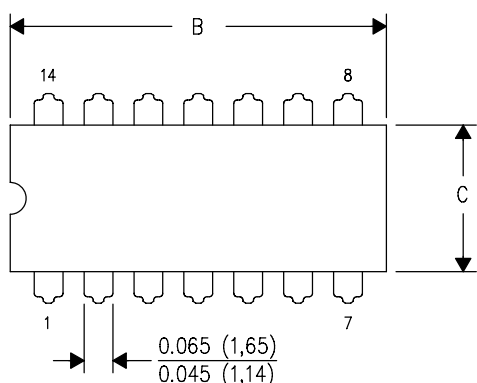
4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AC.

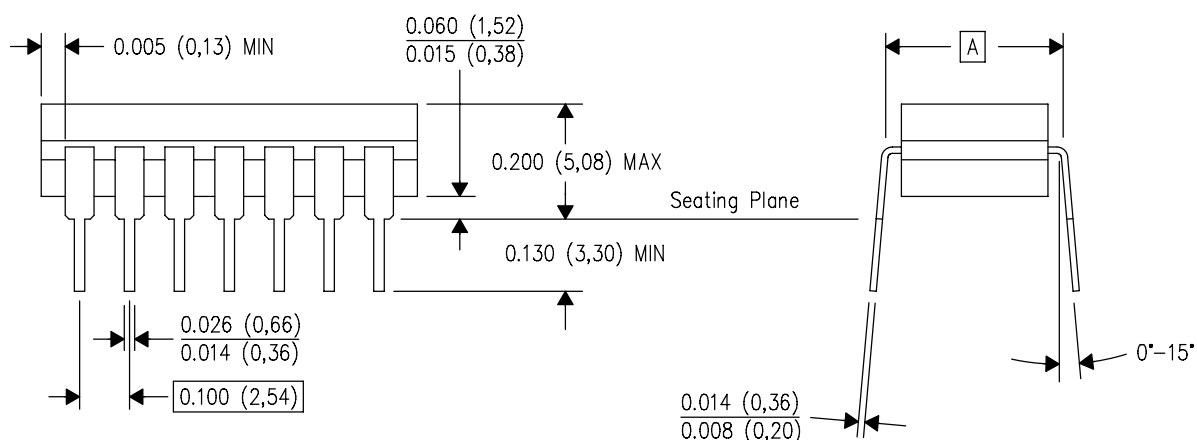
J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



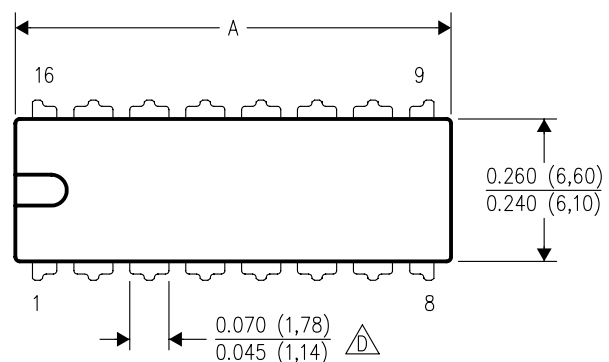
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

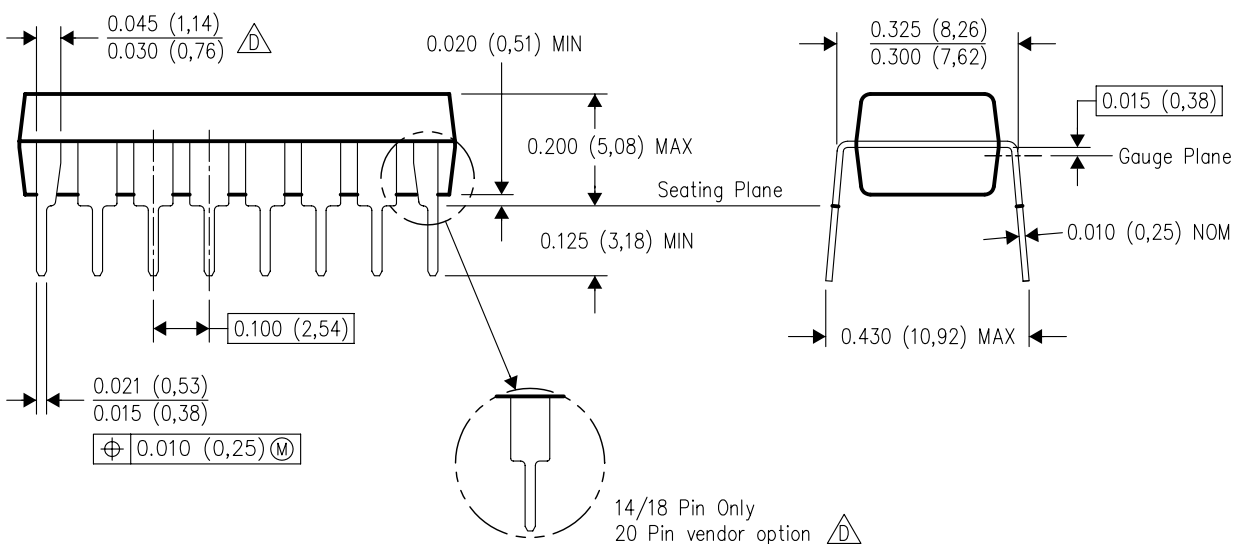
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  -  The 20 pin end lead shoulder width is a vendor option, either half or full width.

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2025, Texas Instruments Incorporated